

N-Channel Enhancement Mode MOSFET

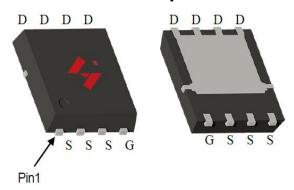
Feature

- 150V/86A
 R_{DS(ON)}=9 mΩ(typ.) @VGS = 10V
- 100% Avalanche Tested
- 100% DVDS
- Reliable and Rugged
- Halogen Free and Green Devices Available (RoHS Compliant)

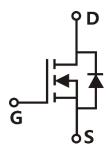
Applications

- UPS (Uninterruptible Power Supply)
- Power Management System

Pin Description



PDFN8L(5x6)



Single N-Channel MOSFET

Ordering and Marking Information



Package Code C2: PDFN8L(5x6)

Date Code XYMXXXXXX

Note: HUAYI halogen free products contain molding compounds/die attach materials and 100% matte tin plate Termi-Nation finish; which are fully compliant with RoHS. HUAYI halogen free products meet or exceed the halogen free require-ments of IPC/JEDEC J-STD-020 for MSL classification at halogen free peak reflow temperature. HUAYI defines "Green" to mean halogen free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

HUAYI reserves the right to make changes, corrections, enhancements, modifications, and improvements to this pr-oduct and/or to this document at any time without notice.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit		
Common Ratings (Tc=25°C Unless Otherwise Noted)					
VDSS	Drain-Source Voltage		150	V	
Vgss	Gate-Source Voltage		±20	V	
TJ	Junction Temperature Range		55 1. 475	°C	
Тѕтс	Storage Temperature Range		-55 to 175	°C	
Is	Source Current-Continuous(Body Diode) Tc=25°C		86	А	
Mounted on I	Large Heat Sink				
Ідм	Pulsed Drain Current *	Tc=25°C	304	А	
1			86	А	
lσ	Continuous Drain Current	Tc=100°C	61	А	
1	Marine or Bernard Province	Tc=25°C	166.7	W	
Po	Maximum Power Dissipation Tc=100°C		83.4	W	
R₀JC	Thermal Resistance, Junction-to-Case		0.9	°C/W	
R _{eJA}	Thermal Resistance, Junction-to-Ambient **		80	°C/W	
Eas	Single Pulsed-Avalanche Energy *** L=0.3mH		200	mJ	

- Note: * Repetitive rating; pulse width limited by max.junction temperature.
 - Surface mounted on 1in2 FR-4 board.
 - Limited by TJmax , starting TJ=25°C, L = 0.3mH, Rg= 25 Ω , VGs =10V.

Electrical Characteristics(Tc =25°C Unless Otherwise Noted)

Compleat	Bonometer.	Took Conditions	HYG100N15HS1			11	
Symbol	Parameter	Parameter Test Conditions		Тур.	Max	Unit	
Static Cha	Static Characteristics						
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V,I _{DS} =250μA	150			V	
	Vps=150V,Vgs=0V	-	-	1	μA		
IDSS	Drain-to-Source Leakage Current	TJ=125°C	-	-	50	μA	
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250µA	3	3.6	4.6	V	
lgss	Gate-Source Leakage Current	Vgs=±20V,Vps=0V	-	-	±100	nA	
RDS(ON)	Drain-Source On-State Resistance	V _{GS} =10V,I _{DS} =50A	-	9	11	mΩ	
Diode Characteristics							
VsD	Diode Forward Voltage	Isp=50A,Vgs=0V	-	0.89		V	
trr	Reverse Recovery Time	Ion-FOA dion/dt-100A/ug	-	24	-	ns	
Qrr	Reverse Recovery Charge	- Isb=50A,dIsb/dt=100A/μs	-	12	-	nC	



Electrical Characteristics (Cont.) (Tc =25°C Unless Otherwise Noted)

O. mala al	Parameter	Took Conditions	HY	HYG100N15HS1		
Symbol		Test Conditions	Min	Тур.	Max	Unit
Dynamic (Characteristics					
Rg	Gate Resistance	V _{GS} =0V,V _{DS} =0V,F=1MHz	-	1.4	-	Ω
Ciss	Input Capacitance	Vgs=0V,	-	1892	-	
Coss	Output Capacitance	V _{DS} =25V,	-	1108	-	pF
Crss	Reverse Transfer Capacitance	Frequency=500KHz	-	50.6	-	
td(ON)	Turn-on Delay Time		-	15	-	
Tr	Turn-on Rise Time	$V_{DD}=75V,R_{G}=4\Omega,$	-	75	-	
td(OFF)	Turn-off Delay Time	Ips=50A,Vgs=10V	-	18.5	-	ns
Tf	Turn-off Fall Time		-	54.6	-	
Gate Charge Characteristics						
Qg	Total Gate Charge(V _{GS} =10V)		-	29	-	
Qgs	Gate-Source Charge	\/ _120\/ _50A	-	11	-	nC
Qgd	Gate-Drain Charge	$-V_{DS}$ =120V, I_{DS} =50A	-	8	-	
V _{plateau}	Gate plateau voltage		-	6.4	-	V

Note: *Pulse test, pulse width ≤ 300 us, duty cycle $\leq 2\%$



Typical Operating Characteristics

Figure 1: Power Dissipation

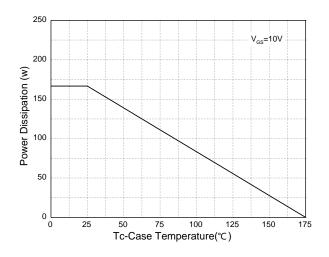


Figure 3: Safe Operation Area

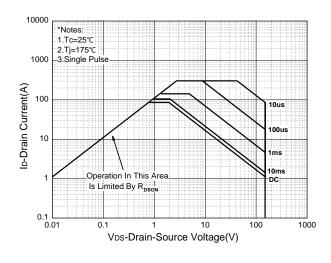


Figure 5: Output Characteristics

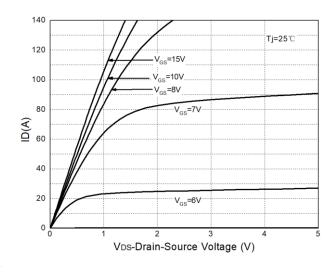


Figure 2: Drain Current

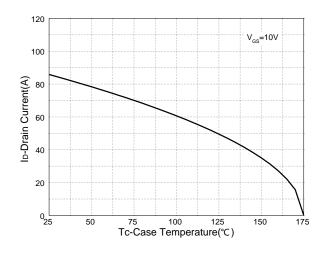


Figure 4: Thermal Transient Impedance

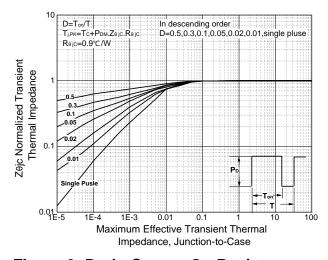
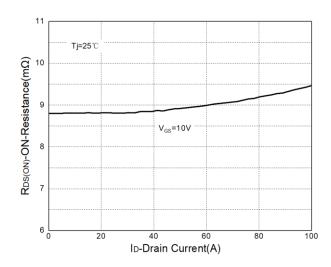


Figure 6: Drain-Source On Resistance





Typical Operating Characteristics(Cont.)

Figure 7: On-Resistance vs. Temperature

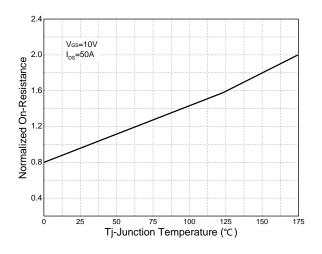


Figure 8: Source-Drain Diode Forward

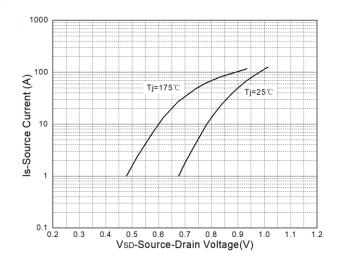


Figure 9: Capacitance Characteristics

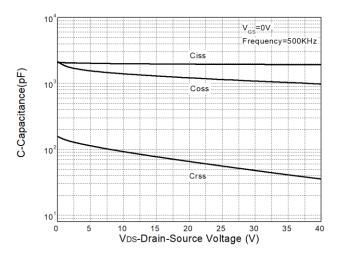
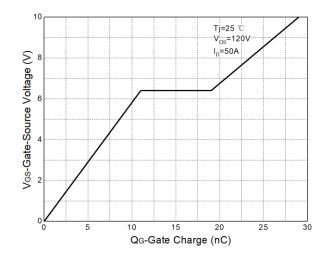
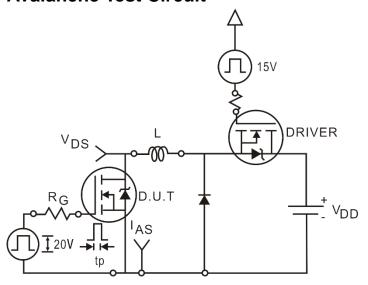


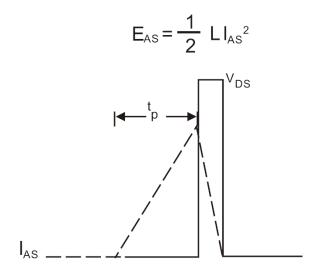
Figure 10: Gate Charge Characteristics



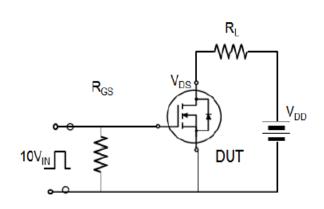


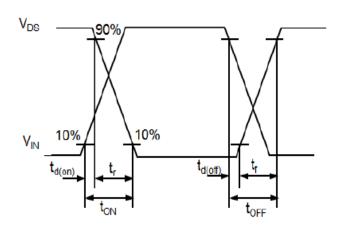
Avalanche Test Circuit



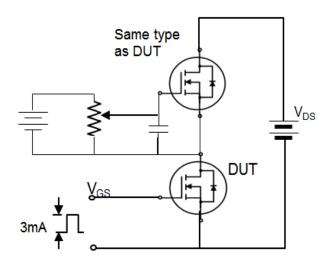


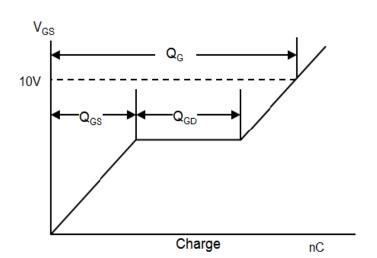
Switching Time Test Circuit





Gate Charge Test Circuit





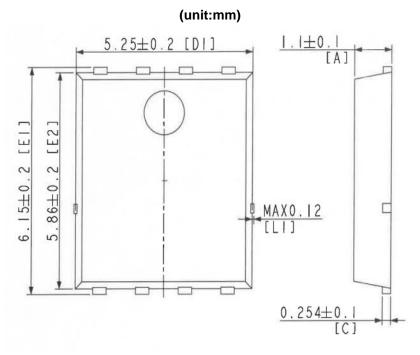


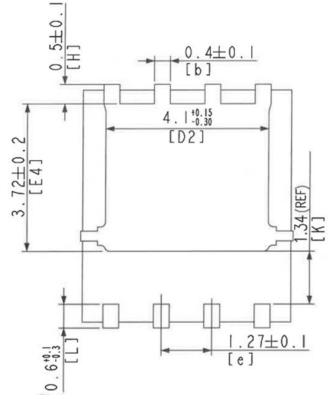
Device Per Unit

Package Type	Unit	Quantity
PDFN8L(5x6)	Reel	5000

Package Information

PDFN8L(5x6)







Classification Profile



Classification Reflow Profiles

Sn-Pb Eutectic Assembly	Pb-Free Assembly			
Preheat & Soak				
100 °C	150 °C			
150 °C	200 °C			
60-120 seconds	60-120 seconds			
2.90/22224 2224	290/20024 720/			
3 C/second max.	3°C/second max.			
183 °C	217 °C			
60-150 seconds	60-150 seconds			
Con Classification Town in table 4	SeeClassification Tempin table 2			
See Classification Temp in table 1	SeeClassification Tempin table 2			
20** accords	20** accords			
20 seconds	30** seconds			
6 °C/second max.	6 °C/second max.			
6 minutes max.	8 minutes max.			
	Preheat & Soak 100 °C 150 °C 60-120 seconds 3 °C/second max. 183 °C 60-150 seconds See Classification Temp in table 1 20** seconds 6 °C/second max.			

^{*}Tolerance for peak profile Temperature (Tp) is defined as a supplier minimum and a user maximum.

^{**} Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.

HYG100N15HS1C2



Table 1.SnPb Eutectic Process – Classification Temperatures (Tc)

Package Thickness	Volume mm³ <350	Volume mm³ ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2.Pb-free Process – Classification Temperatures (Tc)

Package	Volume mm ³	Volume mm³	Volume mm³
Thickness	<350	350-2000	≥2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

Reliability Test Program

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HTRB	JESD-22, A108	168/500 Hrs, Bias @ 150°C
HTGB	JESD-22, A108	168 /500 Hrs, Vgs100% @ 150°C
PCT	JESD-22, A102	96 Hrs, 100%RH, 2atm, 121°C
тст	JESD-22, A104	250/500 Cycles, -55°C~150°C

Customer Service

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